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Vishay Siliconix

P-Channel 30-V (D-S) MOSFET

| PRODUCT SUMMARY | | | | | | |
|---------------------|------------------------------------|---------------------------------|-----------------------|--|--|--|
| V _{DS} (V) | $R_{DS(on)}\left(\Omega\right)$ | I _D (A) ^d | Q _g (Typ.) | | | |
| - 30 | 0.024 at V _{GS} = - 10 V | - 11.4 | 15 nC | | | |
| - 30 | 0.035 at V _{GS} = - 4.5 V | - 9.4 | 13110 | | | |

FEATURES

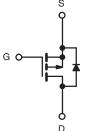
- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET® Power MOSFET
- Compliant to RoHS Directive 2002/95/EC

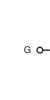


HALOGEN FREE

APPLICATIONS

- Load Switches
- **Battery Switch**





Ordering Information: Si4435DDY-T1-E3 (Lead (Pb)-free)

Top View

SO-8

S

G

Si4435DDY-T1-GE3 (Lead (Pb)-free and Halogen-free)

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P-Channel MOSFET

| Parameter | Symbol | Limit | Unit | |
|-----------------------------------------------------|-----------------------------------|------------------|-----------------------|----|
| Drain-Source Voltage | V _{DS} | - 30 | V | |
| Gate-Source Voltage | V _{GS} | ± 20 | v | |
| | T _C = 25 °C | | - 11.4 | |
| Continuous Drain Current (T _{.1} = 150 °C) | T _C = 70 °C | 1 , [| - 9.1 | |
| Continuous Diairi Current (1) = 150 °C) | T _A = 25 °C | I _D | - 8.1 ^{a, b} | |
| | T _A = 70 °C | | - 6.5 ^{a, b} | |
| Pulsed Drain Current | I _{DM} | - 50 | A | |
| Continuous Source-Drain Diode Current | T _C = 25 °C | | - 4.1 | |
| Continuous Source-Drain Diode Current | T _A = 25 °C | - I _S | - 2.0 ^{a, b} | |
| Avalanche Current | 1 0.4 mll | I _{AS} | - 20 | |
| Single-Pulse Avalanche Energy | L = 0.1 mH | E _{AS} | 20 | mJ |
| | T _C = 25 °C | | 5.0 | |
| Mariana Damar Dissipation | T _C = 70 °C | | 3.2 | w |
| Maximum Power Dissipation | T _A = 25 °C | P _D | 2.5 ^{a, b} | VV |
| | T _A = 70 °C | 1 | 1.6 ^{a, b} | |
| Operating Junction and Storage Temperature Rang | T _J , T _{stq} | - 55 to 150 | °C | |

| THERMAL RESISTANCE RATINGS | | | | | | |
|---------------------------------------------|--------------|-------------------|---------|---------|------|--|
| Parameter | | Symbol | Typical | Maximum | Unit | |
| Maximum Junction-to-Ambient ^{a, c} | t ≤ 10 s | R _{thJA} | 38 | 50 | °C/W | |
| Maximum Junction-to-Foot | Steady State | R _{thJF} | 20 | 25 | C/VV | |

Notes:

- a. Surface mounted on 1" x 1" FR4 board.
- b. t = 10 s.
- c. Maximum under Steady State conditions is 85 °C/W.
- d. Based on T_C = 25 °C.

Si4435DDY

Vishay Siliconix



| Parameter | Symbol | Test Conditions | Min. | Тур. | Max. | Unit | |
|-----------------------------------------------|-------------------------|------------------------------------------------------------------------------------|-------|--------|-------|--------|--|
| Static | | | | | | | |
| Drain-Source Breakdown Voltage | V_{DS} | $V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$ | - 30 | | | V | |
| V _{DS} Temperature Coefficient | $\Delta V_{DS}/T_{J}$ | I _D = - 250 μA | | - 31 | | m\//°C | |
| V _{GS(th)} Temperature Coefficient | $\Delta V_{GS(th)}/T_J$ | | | 4.5 | | mV/°C | |
| Gate-Source Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}, I_{D} = -250 \mu A$ | - 1.0 | | - 3.0 | V | |
| Gate-Source Leakage | I _{GSS} | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$ | | | ± 100 | nA | |
| Zara Cata Valtara Drain Current | I | V _{DS} = - 30 V, V _{GS} = 0 V | | | -1 | | |
| Zero Gate Voltage Drain Current | I _{DSS} | $V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$ | | | - 5 | μΑ | |
| On-State Drain Current ^a | I _{D(on)} | $V_{DS} \ge -10 \text{ V}, V_{GS} = -10 \text{ V}$ | - 30 | | | Α | |
| Durin Course Co Olete Besisters | D | V _{GS} = - 10 V, I _D = - 9.1 A | | 0.0195 | 0.024 | | |
| Drain-Source On-State Resistance ^a | R _{DS(on)} | V _{GS} = - 4.5 V, I _D = - 6.9 A | | 0.028 | 0.035 | Ω | |
| Forward Transconductance ^a | 9 _{fs} | V _{DS} = - 10 V, I _D = - 9.1 A | | 23 | | S | |
| Dynamic ^b | | | | • | | | |
| Input Capacitance | C _{iss} | | | 1350 | | | |
| Output Capacitance | C _{oss} | $V_{DS} = -15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$ | | 215 | | pF | |
| Reverse Transfer Capacitance | C_{rss} | | | 185 | | | |
| Tatal Cata Chayera | | $V_{DS} = -15 \text{ V}, V_{GS} = -10 \text{ V}, I_{D} = -9.1 \text{ A}$ | | 32 | 50 | nC | |
| Total Gate Charge | | | | 15 | 25 | | |
| Gate-Source Charge | Q_{gs} | $V_{DS} = -15 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -9.1 \text{ A}$ | | 4 | | | |
| Gate-Drain Charge | Q _{gd} | | | 7.5 | | | |
| Gate Resistance | R_{g} | f = 1 MHz | | 5.8 | | Ω | |
| Turn-On Delay Time | t _{d(on)} | | | 10 | 15 | | |
| Rise Time | t _r | $V_{DD} = -15 \text{ V}, R_{L} = 15 \Omega$ | | 8 | 15 | | |
| Turn-Off DelayTime | t _{d(off)} | $I_D \cong$ - 1 A, V_{GEN} = - 10 V, R_g = 1 Ω | | 45 | 70 | | |
| Fall Time | ì _f |] | | 12 | 25 | | |
| Turn-On Delay Time | t _{d(on)} | | | 42 | 70 | ns | |
| Rise Time | ìr | V_{DD} = - 15 V, R_{L} = 15 Ω | | 35 | 60 | | |
| Turn-Off DelayTime | t _{d(off)} | $t_{d(off)}$ $I_D \cong -1 \text{ A, } V_{GEN} = -4.5 \text{ V, } R_g = 1 \Omega$ | | 40 | 70 | 1 | |
| Fall Time | ì, í | 1 | | 16 | 30 | | |
| Drain-Source Body Diode Characterist | ics | | | | | | |
| Continous Source-Drain Diode Current | I _S | T _C = 25 °C | | | - 4.1 | | |
| Pulse Diode Forward Current | I _{SM} | | | | - 50 | Α | |
| Body Diode Voltage | V _{SD} | I _S = - 2 A, V _{GS} = 0 V | | - 0.75 | - 1.2 | V | |
| Body Diode Reverse Recovery Time | t _{rr} | | | 34 | 60 | ns | |
| Body Diode Reverse Recovery Charge | Q _{rr} | 1 | | 22 | 40 | nC | |
| Reverse Recovery Fall Time | t _a | $I_F = -2 \text{ A, dI/dt} = 100 \text{ A/}\mu\text{s, T}_J = 25 ^{\circ}\text{C}$ | | 11 | | ns | |
| Reverse Recovery Rise Time | t _b | | | 23 | | | |

Notes:

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

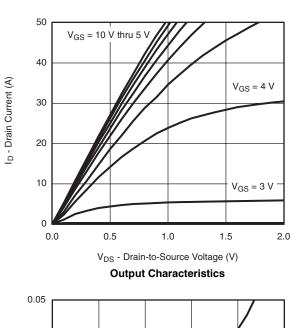
a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

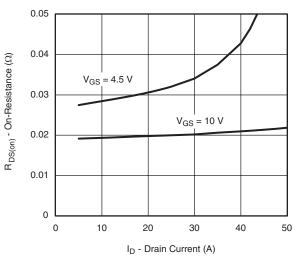
b. Guaranteed by design, not subject to production testing.

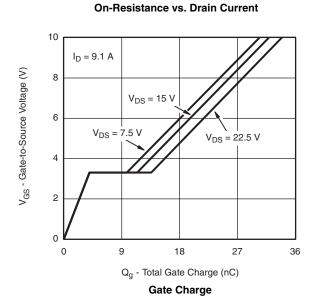


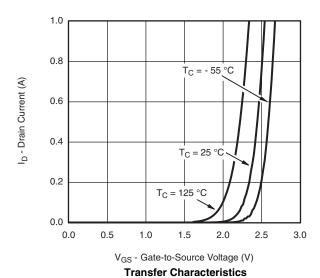
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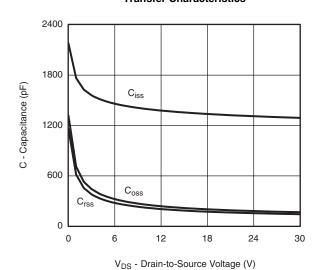
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

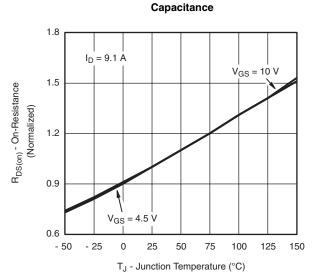










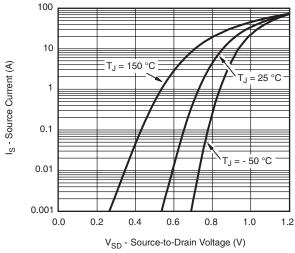


Si4435DDY

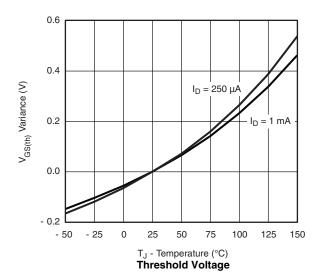
Vishay Siliconix

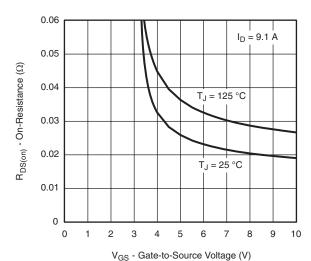
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

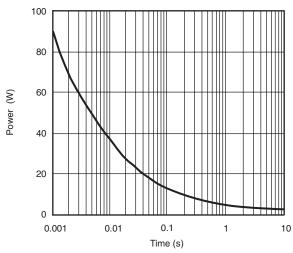


Source-Drain Diode Forward Voltage

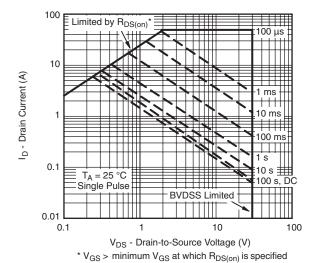




On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient

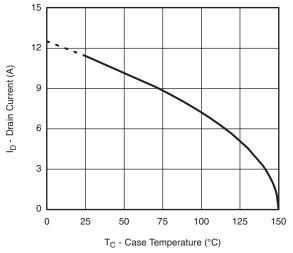


Safe Operating Area

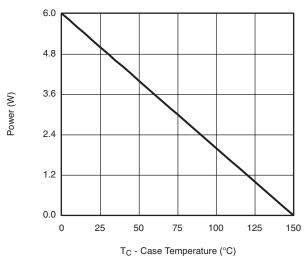


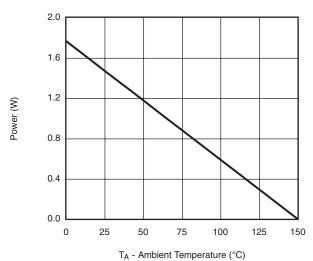
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Current Derating*





Power, Junction-to-Foot

Power Derating, Junction-to-Ambient

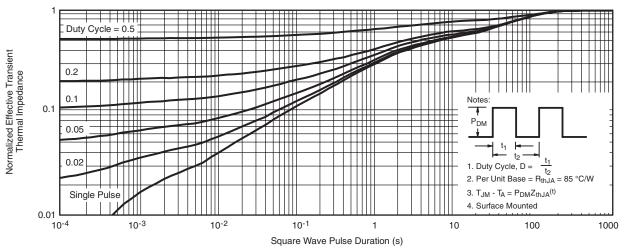
^{*} The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

Si4435DDY

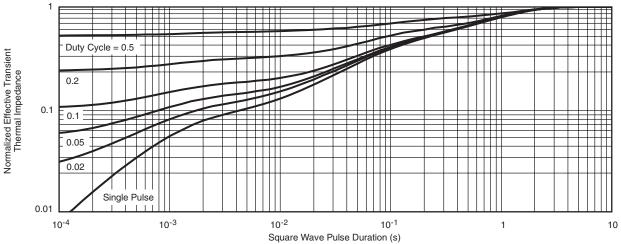
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient

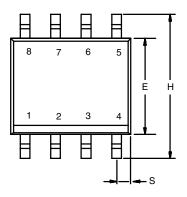


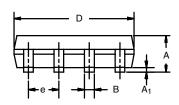
Normalized Thermal Transient Impedance, Junction-to-Foot

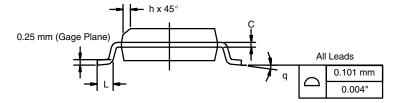
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SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







| | MILLIM | IETERS | INC | INCHES | | |
|--------------------------------|--------|--------|-----------|--------|--|--|
| DIM | Min | Max | Min | Max | | |
| Α | 1.35 | 1.75 | 0.053 | 0.069 | | |
| A ₁ | 0.10 | 0.20 | 0.004 | 0.008 | | |
| В | 0.35 | 0.51 | 0.014 | 0.020 | | |
| С | 0.19 | 0.25 | 0.0075 | 0.010 | | |
| D | 4.80 | 5.00 | 0.189 | 0.196 | | |
| Е | 3.80 | 4.00 | 0.150 | 0.157 | | |
| е | 1.27 | BSC | 0.050 BSC | | | |
| Н | 5.80 | 6.20 | 0.228 | 0.244 | | |
| h | 0.25 | 0.50 | 0.010 | 0.020 | | |
| L | 0.50 | 0.93 | 0.020 | 0.037 | | |
| q | 0° | 8° | 0° | 8° | | |
| S | 0.44 | 0.64 | 0.018 | 0.026 | | |
| ECN: C-06527-Rev. I. 11-Sep-06 | | | | | | |

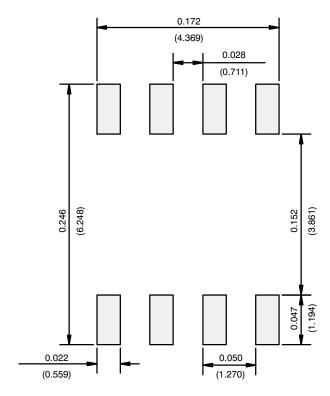
DWG: 5498

Document Number: 71192 www.vishay.com 11-Sep-06

APPLICATION NOTE



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

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